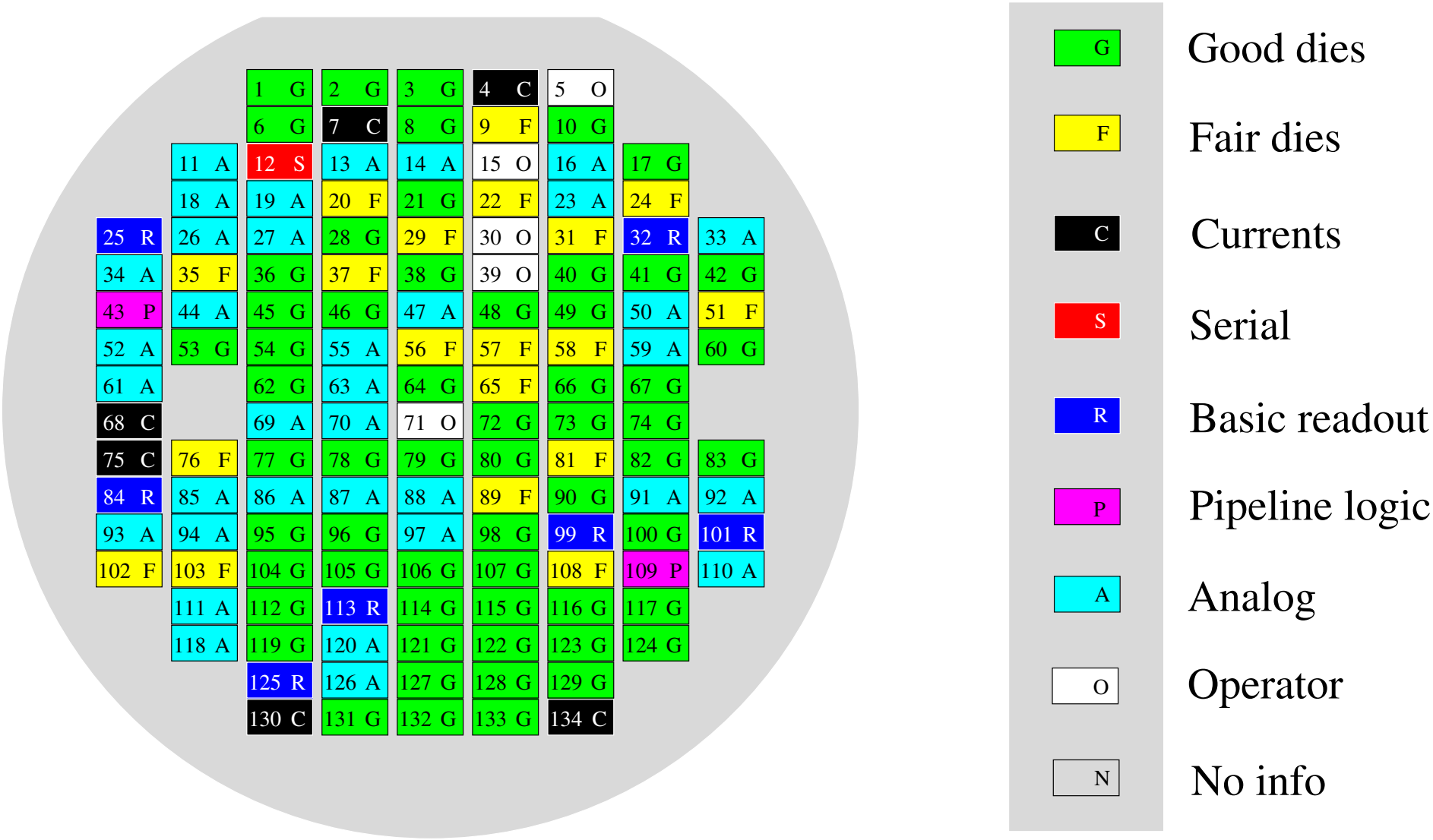
Types of die failures for wafer 137 s/n: Y21316-12-12 (not backplated)

Date: 04/05/99